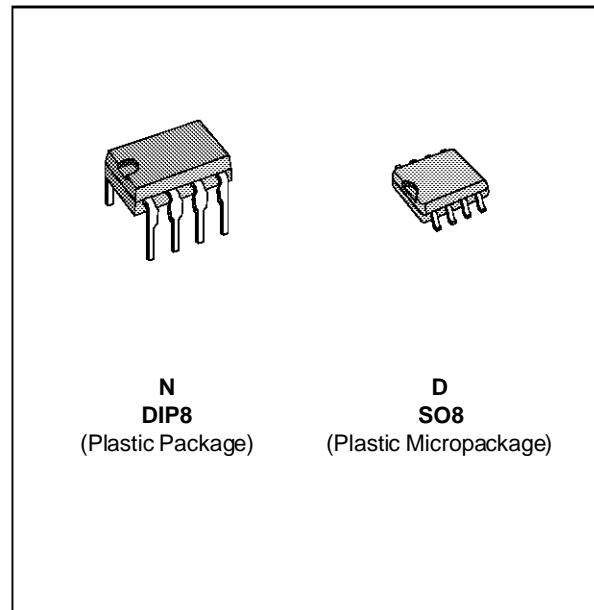


DUAL BIPOLAR OPERATIONAL AMPLIFIERS

- LOW DISTORTION RATIO
- LOW NOISE
- VERY LOW SUPPLY CURRENT
- LOW INPUT OFFSET CURRENT
- VERY LOW INPUT OFFSET VOLTAGE
- LARGE COMMON-MODE RANGE
- HIGH GAIN
- HIGH OUTPUT CURRENT
- GAIN-BANDWIDTH PRODUCT : 2.5MHz
- TEMPERATURE DRIFT : $2\mu\text{V}/^\circ\text{C}$
- LONG TERM STABILITY : $8\mu\text{V}/\text{YEAR}$
(for $T_{\text{amb}} \leq 50^\circ\text{C}$)



DESCRIPTION

The TEB1033, TEF1033 and TEC1033 are high performance dual-operational amplifiers intended for active filter applications. The internal phase compensation allows stable operation as voltage follower in spite of their high gain-bandwidth products. The circuits present very stable electrical characteristics over the entire supply voltage range.

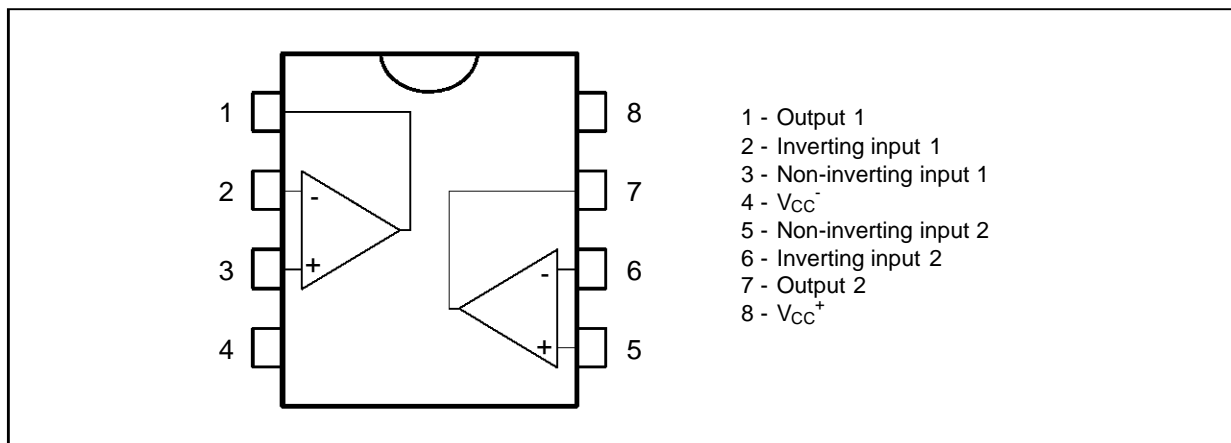
ORDER CODES

Part Number	Temperature Range	Package	
		N	D
TEB1033	0°C, +70°C	•	•
TEF1033	-40°C, +105°C	•	•
TEC1033	-55°C, +125°C	•	•

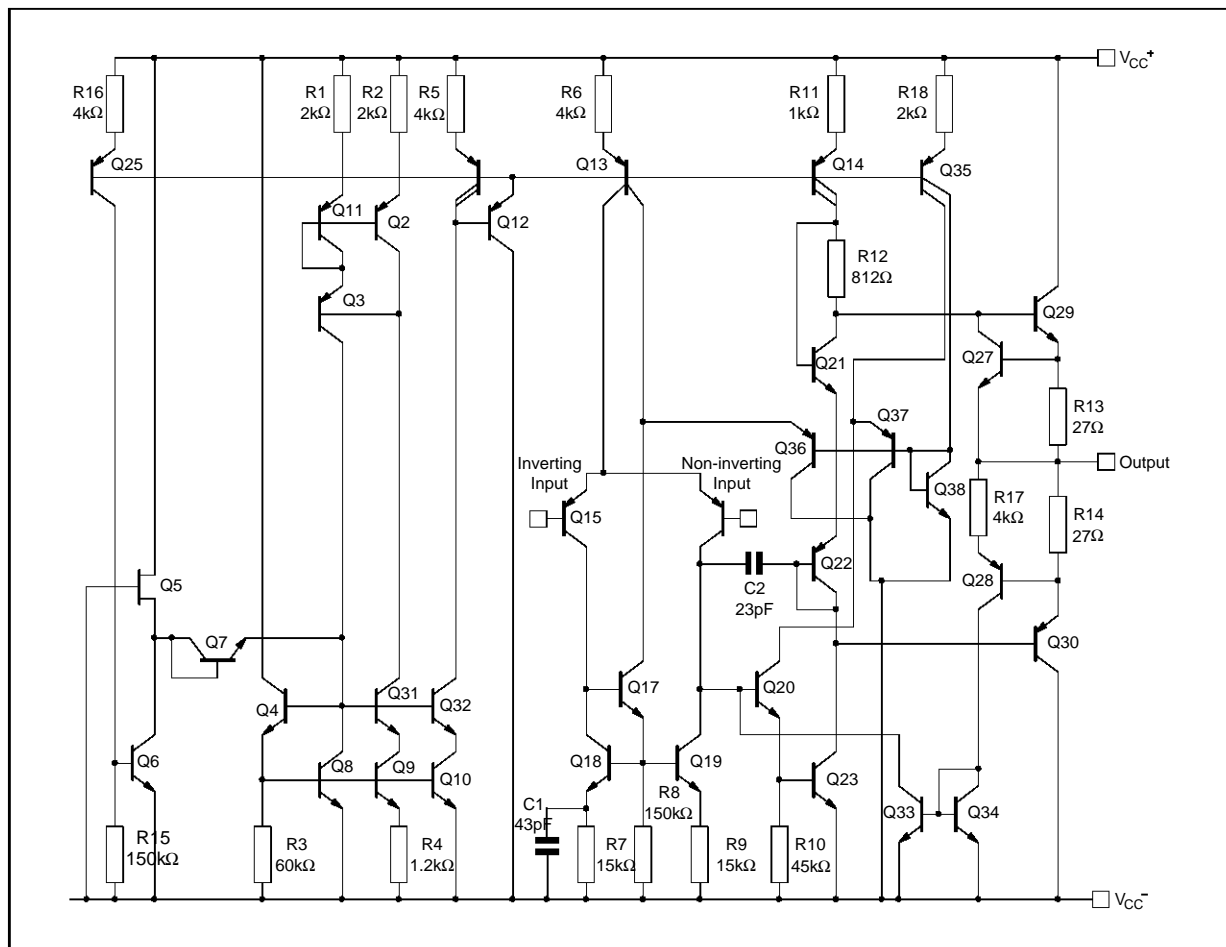
Example : TEB1033N

1033-01.TBL

PIN CONNECTIONS (top view)



BLOCK DIAGRAM (1/2 TEB1033)



1033-03.EPS

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit	
V _{cc}	Supply Voltage	± 18	V	
V _i	Input Voltage	± V _{cc}	V	
V _{id}	Differential Input Voltage	± (V _{cc} - 1)	V	
P _{tot}	Power Dissipation	D suffix N suffix	400 665	mW
T _{oper}	Operating Free-air Temperature Range	TEB1033 TEF1033 TEC1033	0 to +70 -40 to +105 -55 to +125	°C
T _{stg}	Storage Temperature Range		-65 to +150	°C

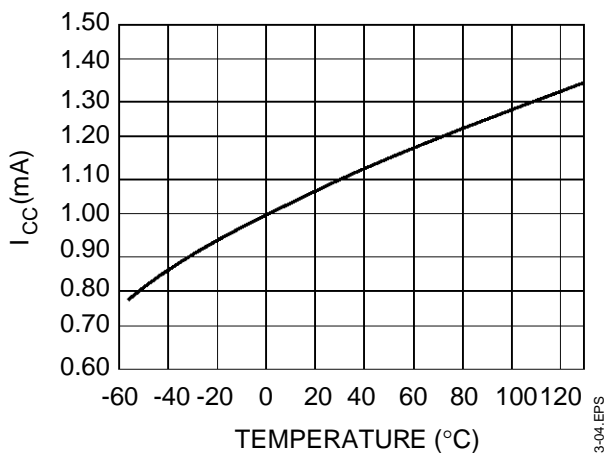
1033-02.TBL

ELECTRICAL CHARACTERISTICSV_{CC} = ±15V, T_{amb} = +25°C (unless otherwise specified)

Symbol	Parameter	TEB 1033 TEF 1033 TEC 1033			Unit
		Min.	Typ.	Max.	
V _{io}	Input Offset Voltage (R _S ≤ 10kΩ) T _{amb} = 25°C T _{min.} ≤ T _{amb} ≤ T _{max.}		0.3	1 3	mV
DV _{io}	Input Offset Voltage Drift		2		μV/°C
I _{io}	Input Offset Current T _{amb} = 25°C T _{min.} ≤ T _{amb} ≤ T _{max.}		5	20 40	nA
I _{ib}	Input Bias Current T _{amb} = 25°C T _{min.} ≤ T _{amb} ≤ T _{max.}		50	100 200	nA
A _{vd}	Large Signal Voltage Gain (R _L = 2kΩ, V _O = ±10V) T _{amb} = 25°C T _{min.} ≤ T _{amb} ≤ T _{max.}	80 40	120		V/mV
SVR	Supply Voltage Rejection Ratio (DV _{CC} from ±15V to ±4V) T _{amb} = 25°C T _{min.} ≤ T _{amb} ≤ T _{max.}	80 70	100		dB
I _{CC}	Supply Current, all Amp, no Load T _{amb} = 25°C T _{min.} ≤ T _{amb} ≤ T _{max.}		1	1.5 2	mA
V _{icm}	Input Common Mode Voltage Range T _{amb} = 25°C	±12			V
CMR	Common Mode Rejection Ratio (R _S ≤ 10kΩ, V _{ic} = ±10V) T _{amb} = 25°C T _{min.} ≤ T _{amb} ≤ T _{max.}	80 70	100		dB
I _{os}	Output Short-circuit Current T _{amb} = 25°C T _{min.} ≤ T _{amb} ≤ T _{max.}	10 10	23	40 40	mA
± V _{opp}	Output Voltage Swing T _{amb} = 25°C T _{min.} ≤ T _{amb} ≤ T _{max.} V _{CC} = ±4V, R _L = 2kΩ, T _{amb} = 25°C V _{CC} = ±6V, R _L = 600Ω, T _{amb} = 25°C		R _L = 2kΩ 13 12 3 4.6		V
SR	Slew-rate (V _I = ±10V, R _L = 2 kΩ, C _L = 100pF, T _{amb} = 25°C, unity gain)	0.6	1		V/μs
GBP	Gain Bandwidth Product (f = 100kHz, T _{amb} = 25°C, V _{in} = 10mV, R _L = 2kΩ, C _L = 100pF)	1.5	2		MHz
R _I	Input Resistance		1		MΩ
THD	Total Harmonic Distortion (f = 1kHz, A _v = 20dB, R _L = 2kΩ, C _L = 100pF, T _{amb} = 25°C, V _o = 2V _{pp})		0.008	0.05	%
e _n	Equivalent Input Noise Voltage (f = 1kHz) R _S = 50Ω R _S = 1kΩ R _S = 10kΩ		8 10 18	15	$\frac{nV}{\sqrt{Hz}}$
V _{OPP}	Large Signal Voltage Swing R _L = 10kΩ, f = 10kHz	26	28		V
∅ _m	Phase Margin		45		Degrees
V _{O1} /V _{O2}	Channel Separation	100	120		dB

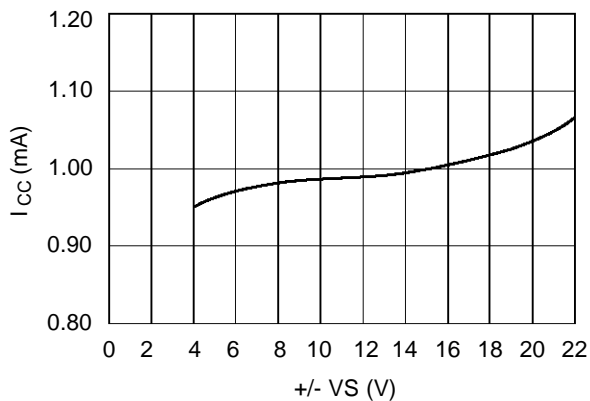
1033-03.TBL

SUPPLY CURRENT VERSUS AMBIENT TEMPERATURE



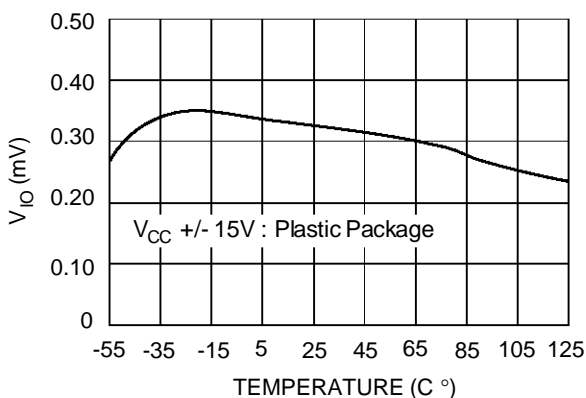
1033-04.EPS

SUPPLY CURRENT VERSUS SUPPLY VOLTAGE



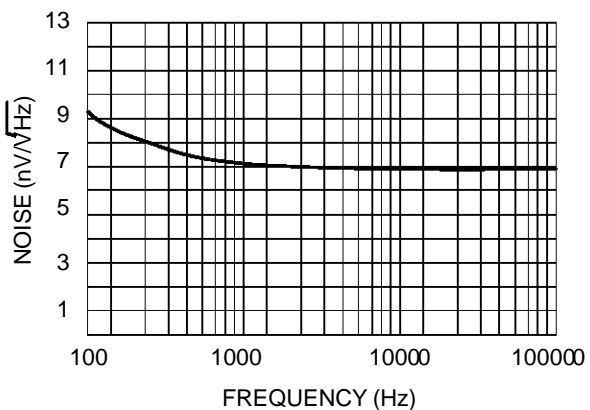
1033-05.EPS

OFFSET VOLTAGE VERSUS AMBIENT TEMPERATURE



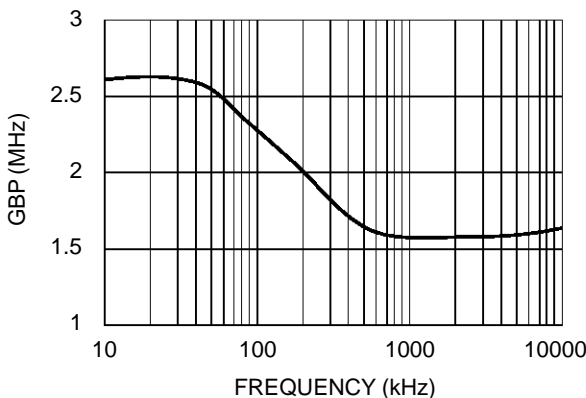
1033-06.EPS

TOTAL INPUT NOISE VERSUS FREQUENCY



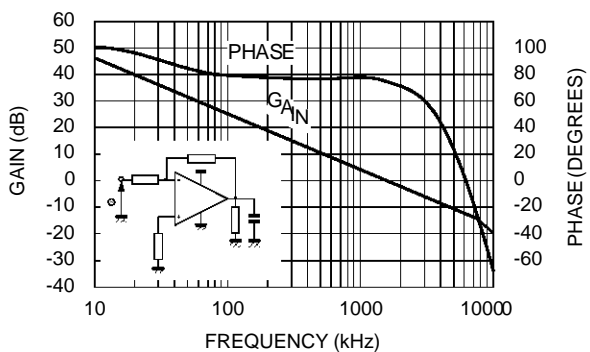
1033-07.EPS

GAIN BANDWIDTH PRODUCT VERSUS FREQUENCY



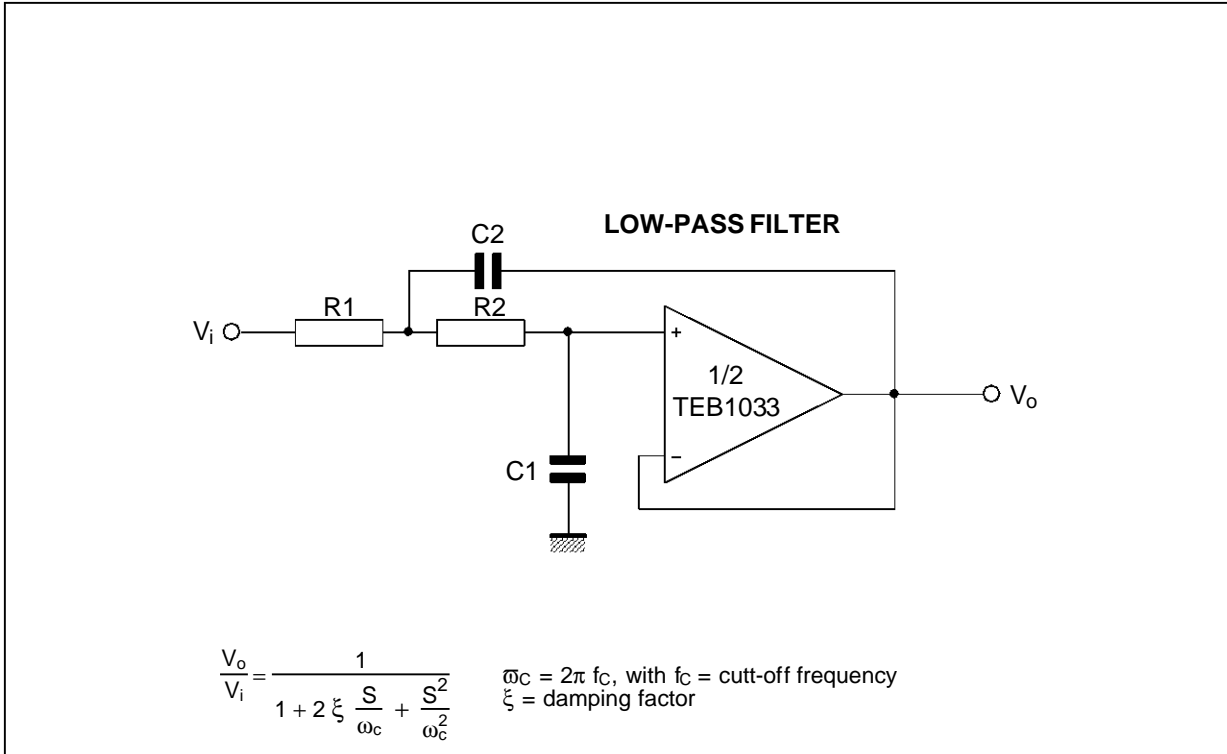
1033-08.EPS

DODE PLOT



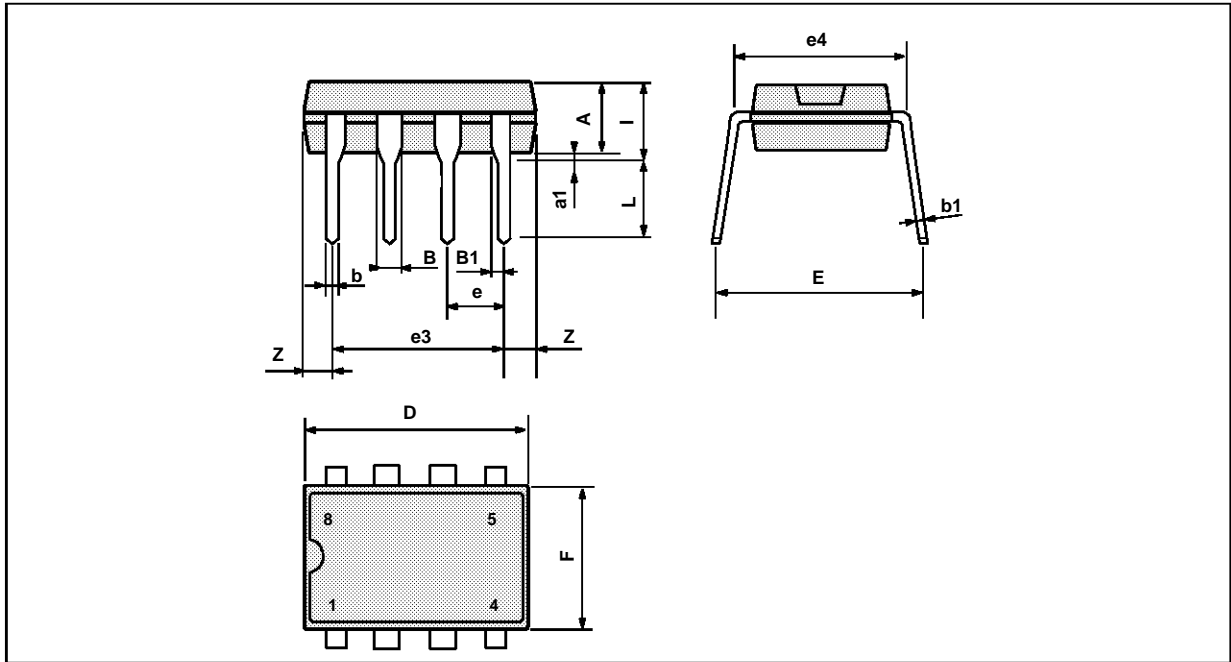
1033-09.EPS

TYPICAL APPLICATION



1033-10.EPS

PACKAGE MECHANICAL DATA
8 PINS - PLASTIC DIP OR CERDIP

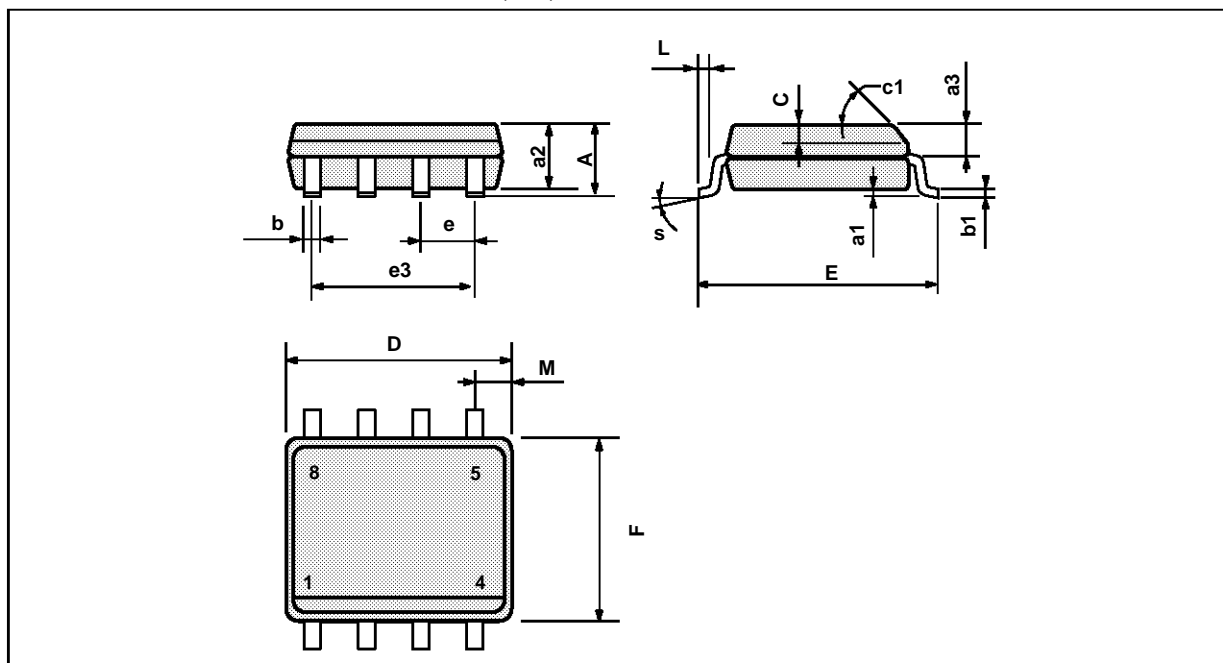


PM-DIP8.EPS

Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A		3.32			0.131	
a1	0.51			0.020		
B	1.15		1.65	0.045		0.065
b	0.356		0.55	0.014		0.022
b1	0.204		0.304	0.008		0.012
D			10.92			0.430
E	7.95		9.75	0.313		0.384
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			6.6			0.260
i			5.08			0.200
L	3.18		3.81	0.125		0.150
Z			1.52			0.060

DIP8.TBL

PACKAGE MECHANICAL DATA
8 PINS - PLASTIC MICROPACKAGE (SO)



PM-S08-EPS

Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
a1	0.1		0.25	0.004		0.010
a2			1.65			0.065
a3	0.65		0.85	0.026		0.033
b	0.35		0.48	0.014		0.019
b1	0.19		0.25	0.007		0.010
C	0.25		0.5	0.010		0.020
c1	45° (typ.)					
D	4.8		5.0	0.189		0.197
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.150		0.157
L	0.4		1.27	0.016		0.050
M			0.6			0.024
S	8° (max.)					

S08.TBL

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